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(12) **United States Design Patent**  
**Zheng**

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(54) **AUDIO HEADSET**

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(52) **U.S. Cl.**  
USPC ..... **D14/206**

(58) **Field of Classification Search**

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D29/112; 2/209; 381/380-381, 374,  
381/371-372

CPC ..... H04R 25/00; H04R 25/02; H04R 1/02;  
H04R 5/00; H04R 5/02; H04R 1/1066;  
H04R 1/1016; H04R 5/033; H04R  
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H04R 1/1091

See application file for complete search history.

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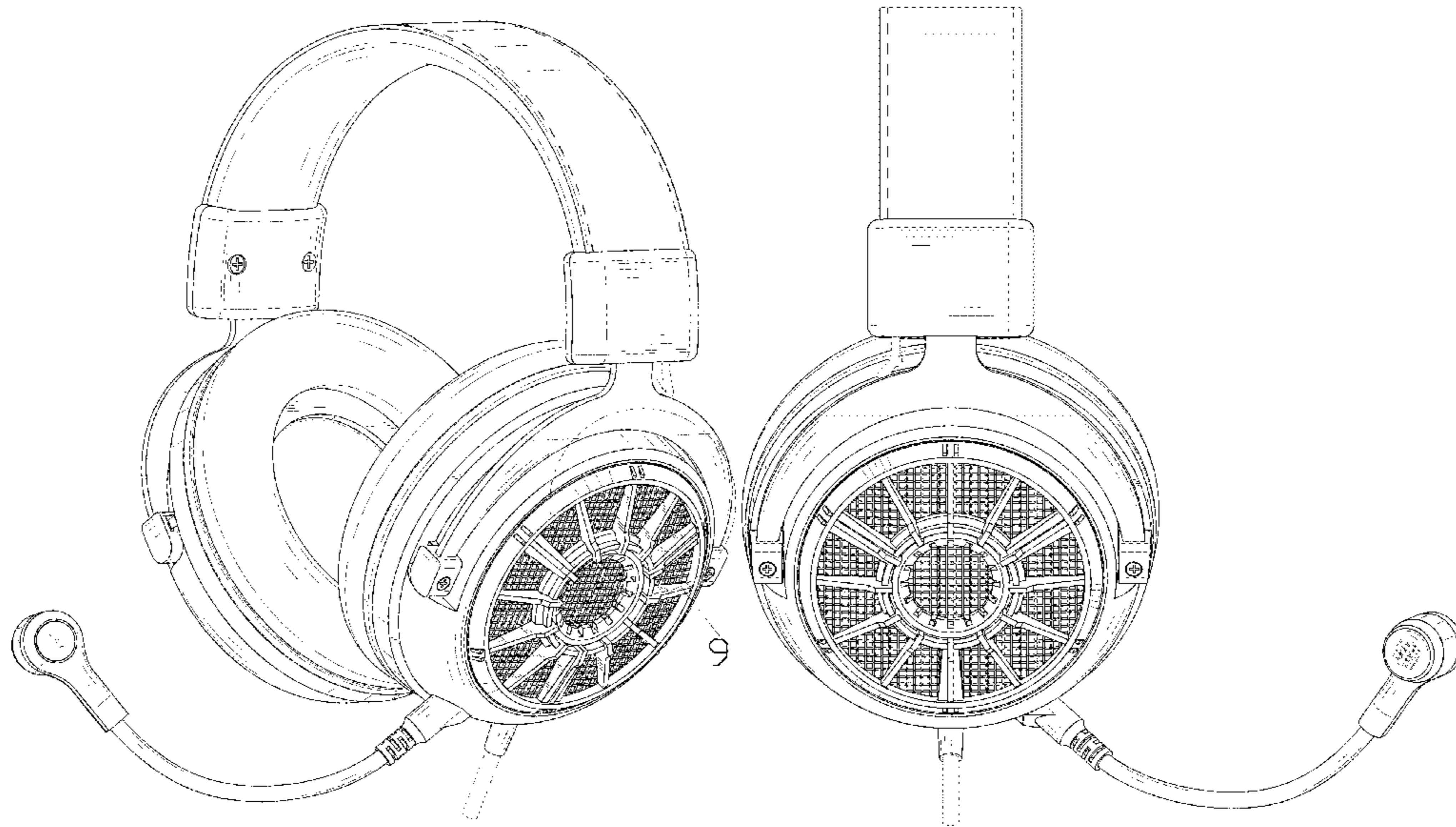
(57) **CLAIM**

The ornamental design for an audio headset, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of an audio headset showing my new design;  
FIG. 2 is another perspective view thereof;  
FIG. 3 is a front elevational view thereof;  
FIG. 4 is a rear elevational view thereof;  
FIG. 5 is a left side elevational view thereof;  
FIG. 6 is a right side elevational view thereof;  
FIG. 7 is a top plan view thereof;  
FIG. 8 is a bottom plan view thereof; and,  
FIG. 9 is an enlarged view of portion 9 shown in FIG. 1.  
The short thin broken lines in the drawings depict portions of the audio headset that form no part of the claimed design. The long thick evenly spaced broken lines on the audio headset headband represents stitching. The dot-dash broken lines surrounding portions of the audio headset in FIG. 1 and illustrated in the enlarged view of FIG. 9 form no part of the claimed design.

**1 Claim, 9 Drawing Sheets**



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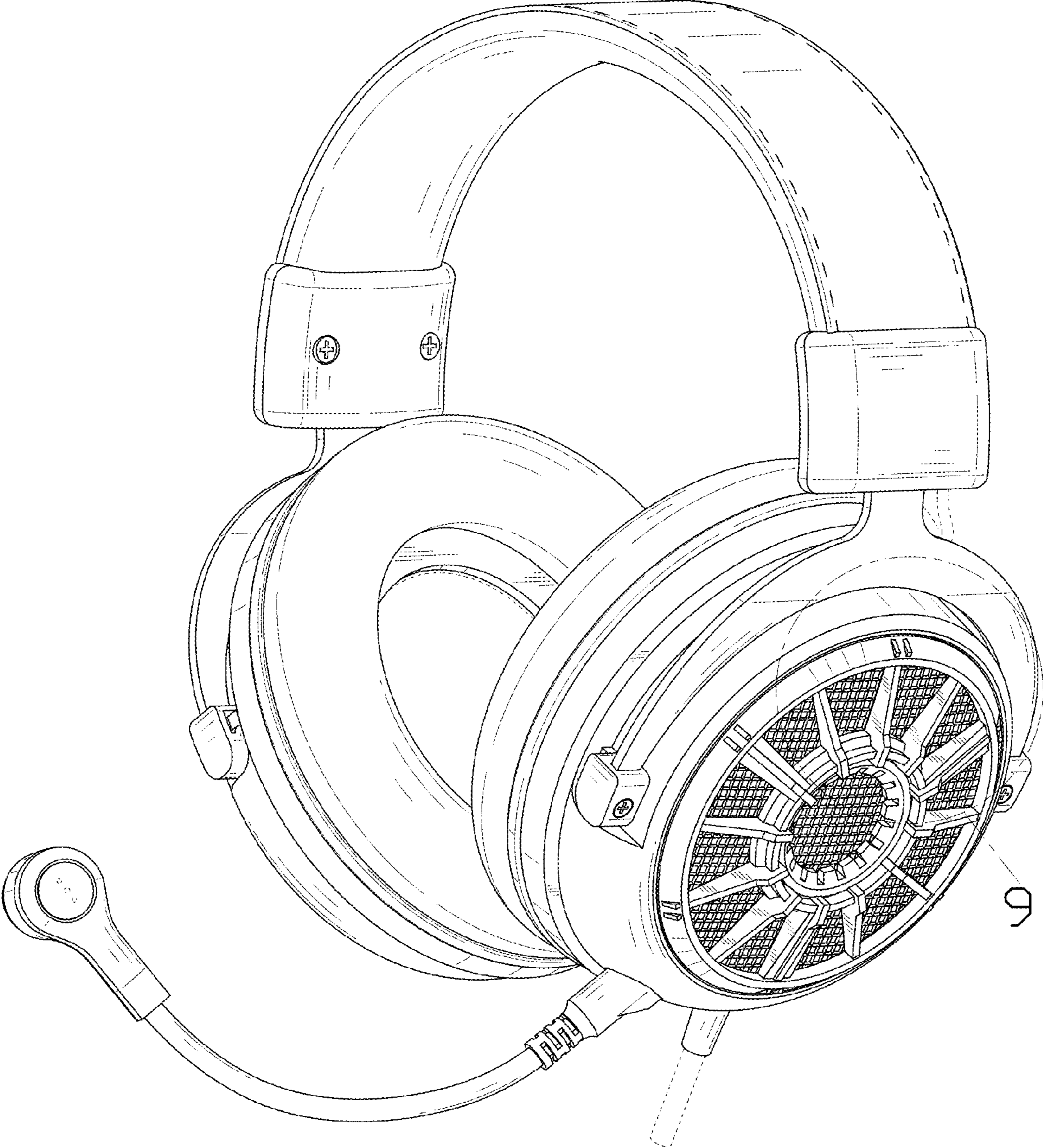


FIG. 1

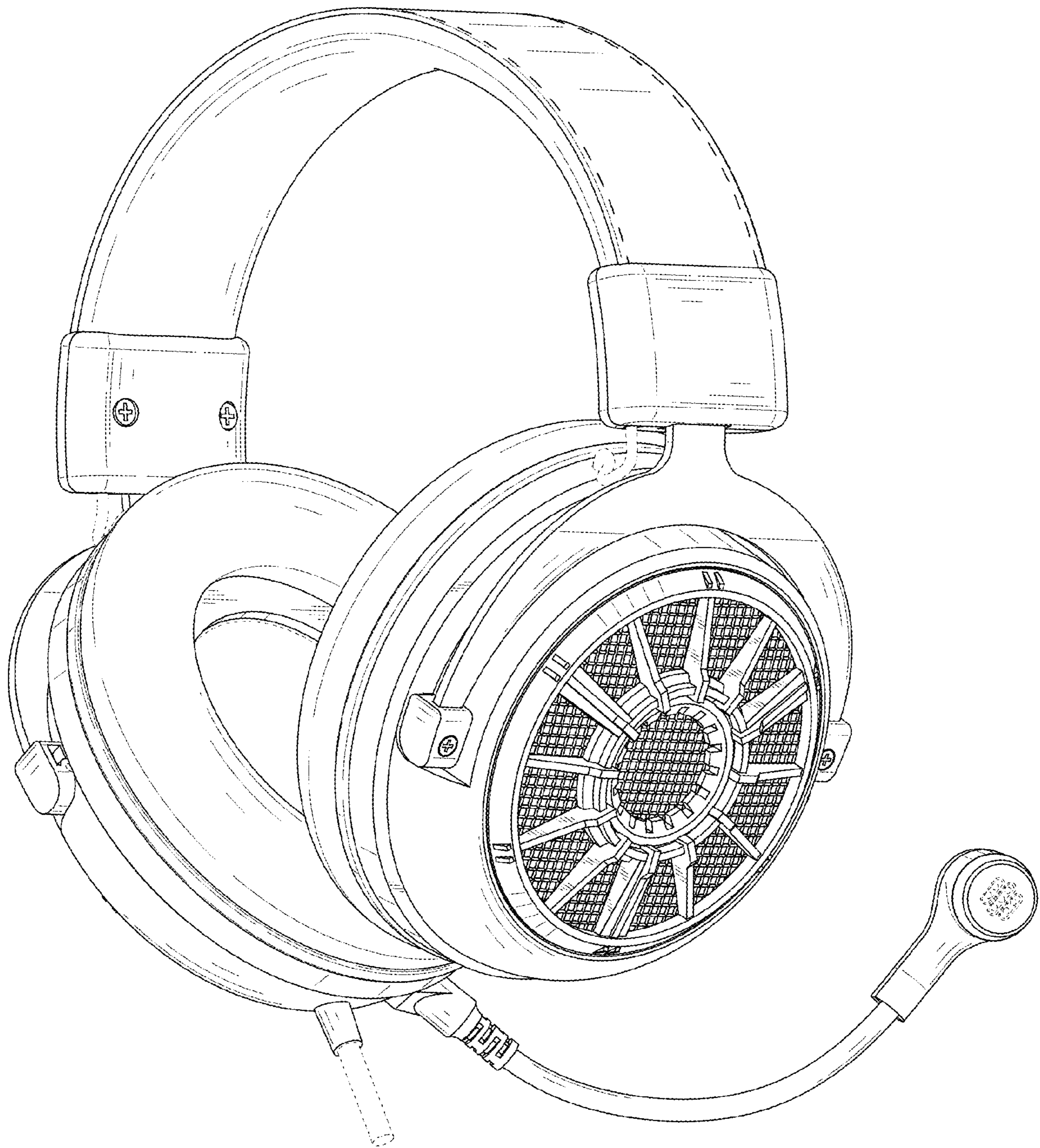


FIG. 2



FIG. 3



FIG. 4



FIG. 5

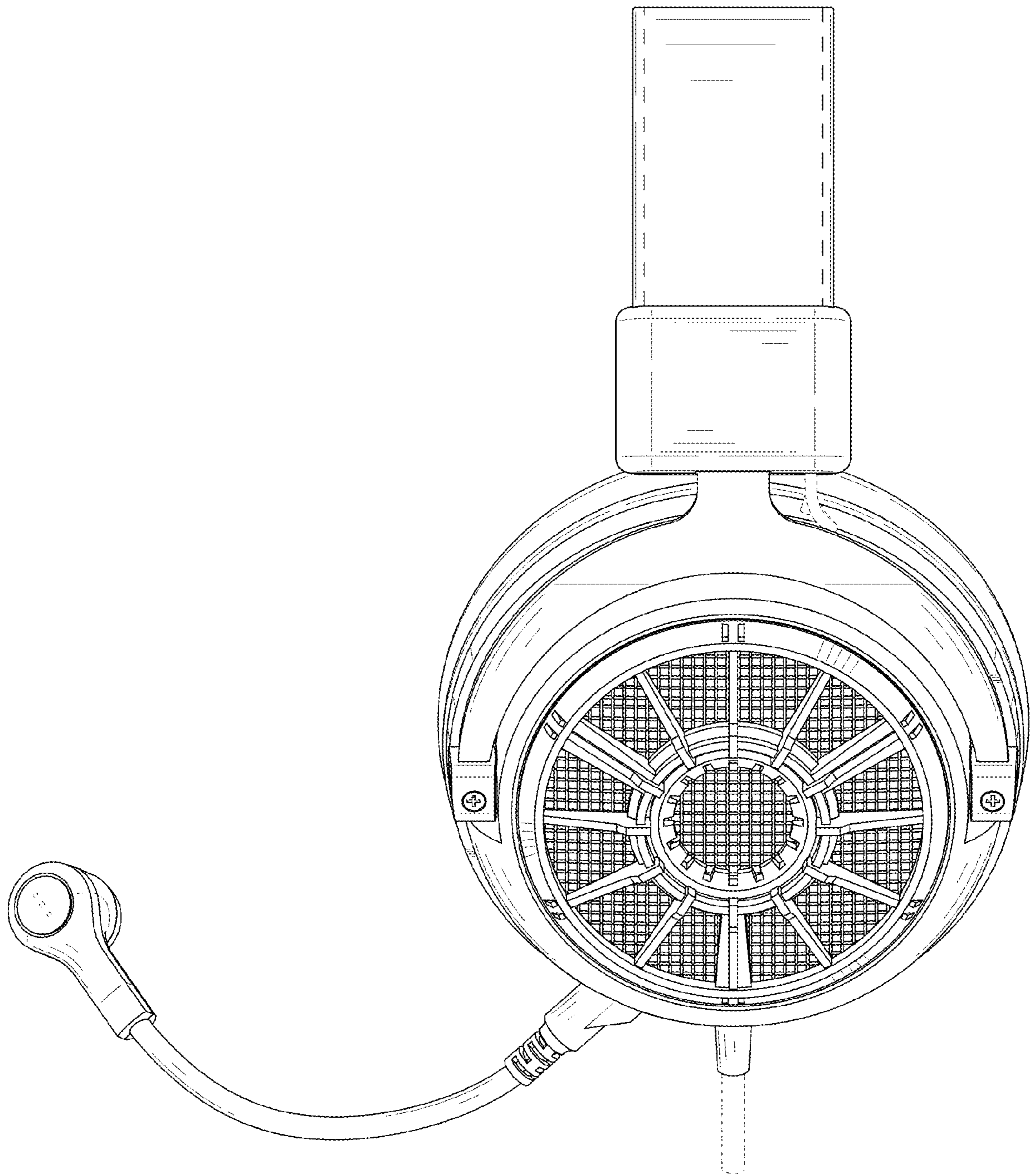


FIG. 6



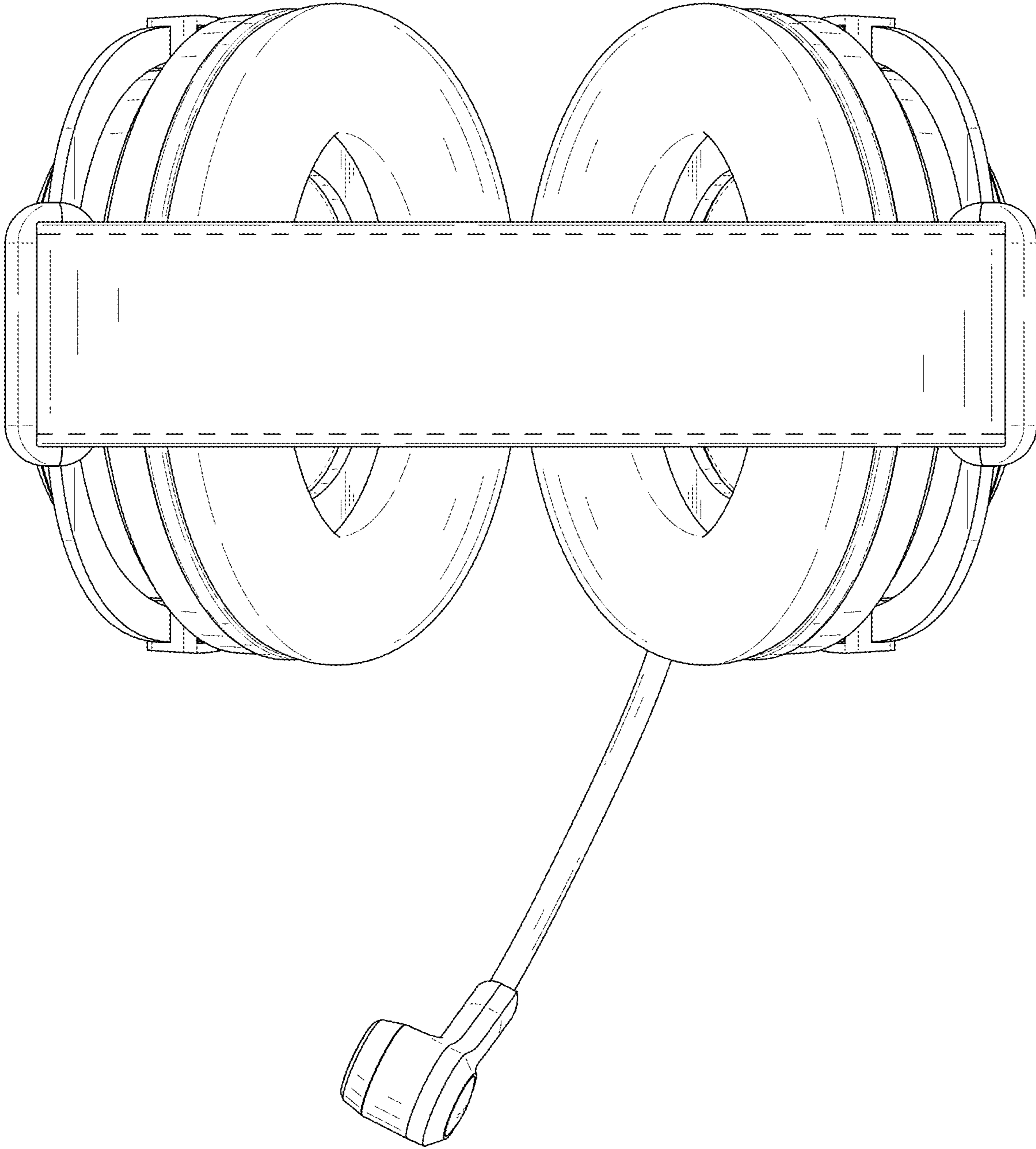


FIG. 7

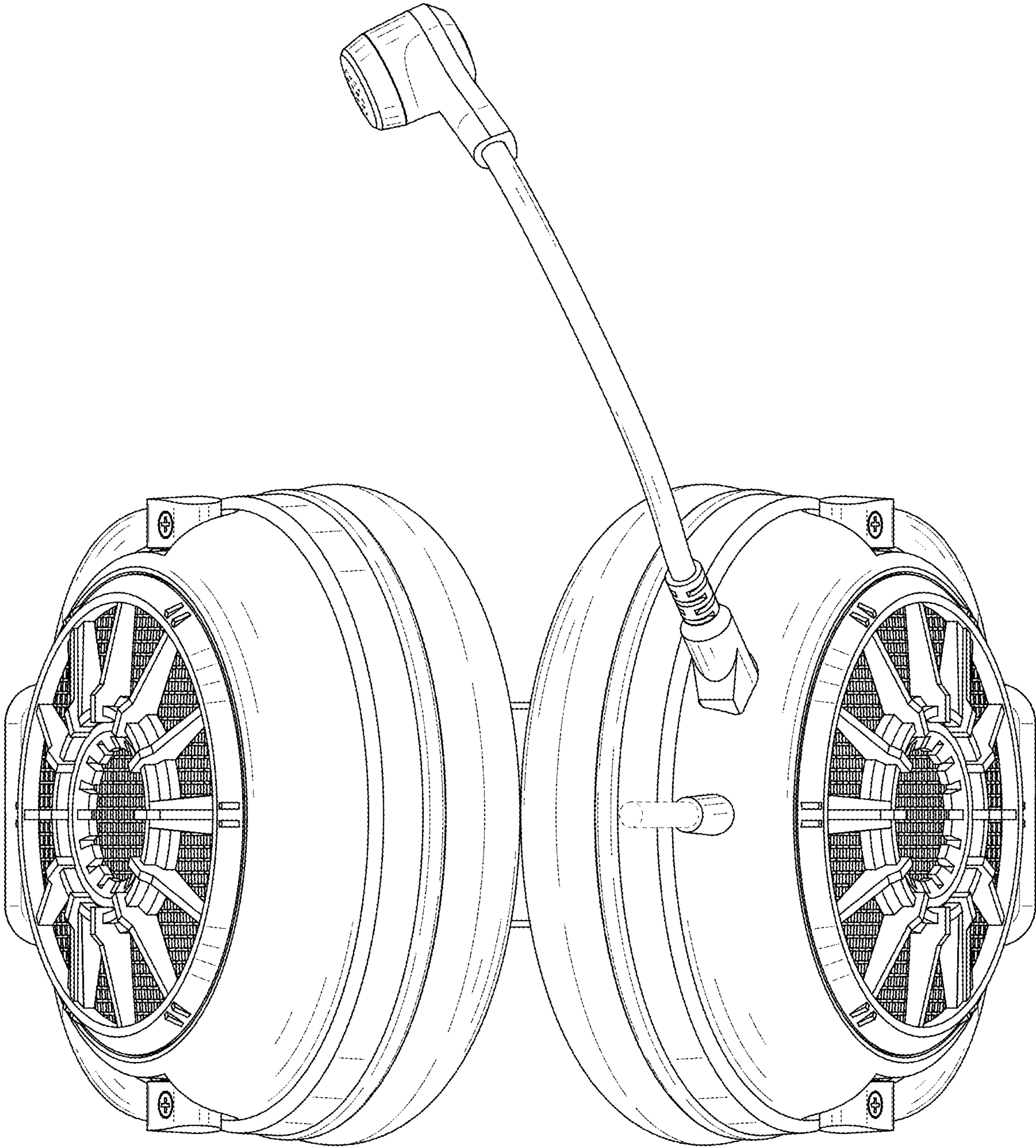


FIG. 8

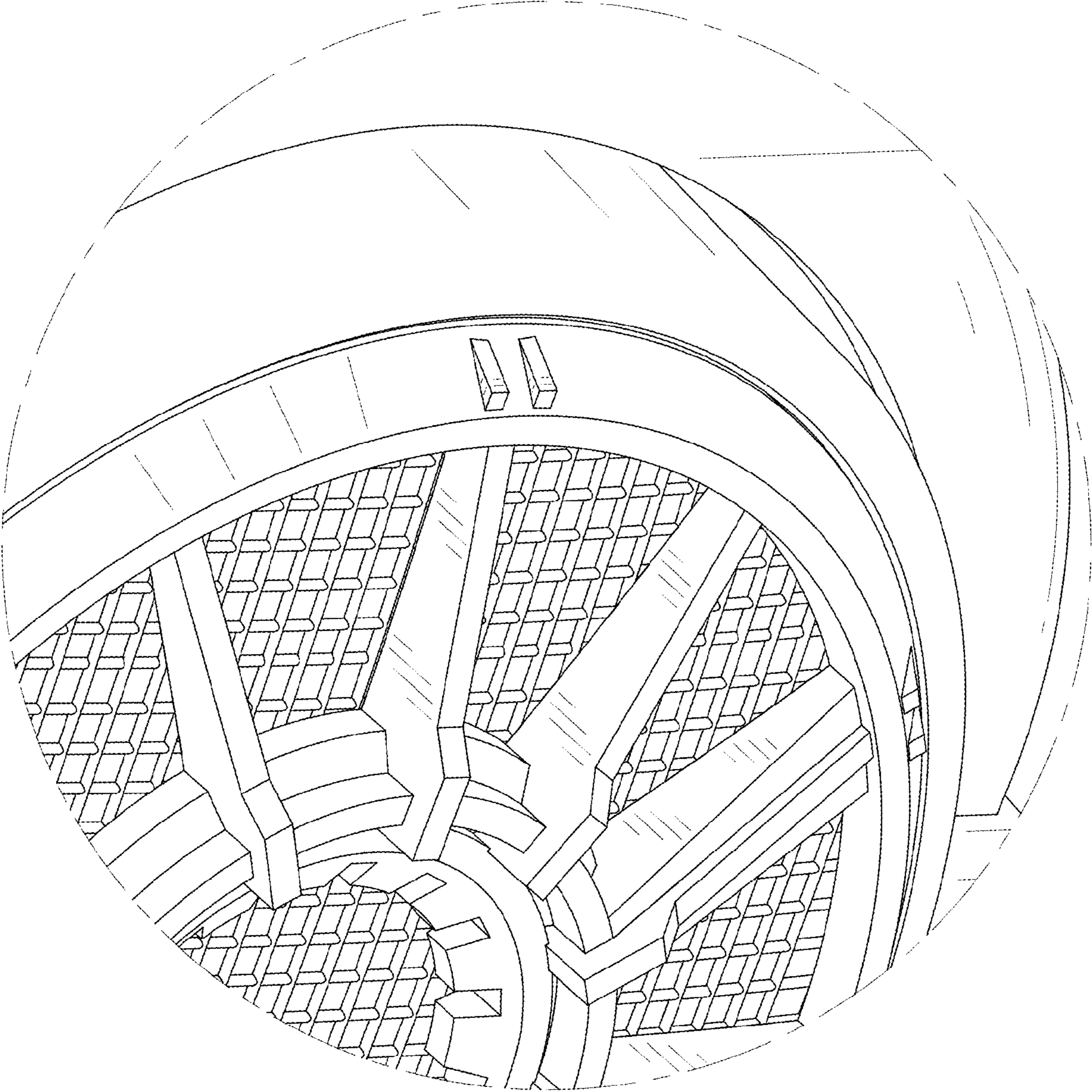


FIG. 9